

## IFW &

**PATENT** 

## In The United States Patent and Trademark Office

In re Application of:

Assignee: Technologies and Devices International,

Inc.

Inventors: Vladimir A. Dmitriev, et al.

Application No: 10/623,375

Filed: July 18, 2003

Title: Manufacturing Methods for Semiconductor

Devices With Multiple III-V Material Layers

Docket No.: 700625-4001

Art Unit: 1765

Examiner: Song, Matthew J.

CERTIFICATE OF MAILING UNDER 37 CFR § 1.8

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I hereby certify that this paper and all enclosures are being deposited with the United States Postal Service as first class mail on the date indicated above in an envelope addressed to Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450.

Type or Print Name of Person Mailing: Karen Wuerfel

Signature of Person Mailing

## **RESPONSE TO OFFICE ACTION**

Mail Stop Amendment Commissioner for Patents P. O. Box 1450 Alexandria, Virginia 22313-1450

## Commissioner:

In response to the Office Action mailed December 29, 2004, the Applicants respectfully submit the following remarks.